

#### Features

- Patented coplanar structure DMC-Isolator®
- Peak Output Current: IOP = ±2.5A (max)
- Threshold Input Current: IFLH = 5 mA (max)
- Common mode transient immunity : ±25kV/µs (min)
- Under voltage lock out (UVLO) protection with hysteresis
- RoHS and REACH Compliance
- Halogen Free Compliance (Optional)
- MSL class 1
- Regulatory Approvals
  - ✓ UL UL1577 (E364000)
  - ✓ VDE EN60747-5-5(VDE0884-5)
  - ✓ CQC GB4943.1, GB8898(19001231775)
  - ✓ IEC62368 (FI/41119)

#### **Description**

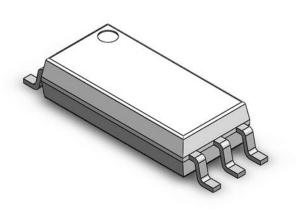
The CTL5702 consists of a LED optically coupled to an integrated circuit with a power output stage. This optocoupler is ideally suited for driving power IGBTs and MOSFETs used in motor control inverter applications. The high operating voltage range of the output stage provides the drive voltages required by gate-controlled devices.

CTL5702

### Applications

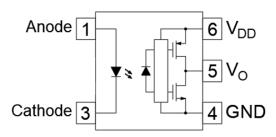
- Isolated IGBT/Power MOSFET gate drive
- Industrial Inverter
- AC brushless and DC motor drives
- Induction Heating

### **Package Outline**



#### Note: Different lead forming options available. See package dimension.

### Schematic



#### **Truth Table**

	Vcc-V <sub>EE</sub>	Vcc-V <sub>EE</sub>				
LED	Positive	Negative	Output			
	Going	Going				
Off	0 to 30 V	0 to 30V	Low			
On	0 to 11.0V	0 to 9.5V	Low			
On	11.0 to13.5V	9.5 to 12V	Transition			
On	13.5 to 30V	12 to 30V	High			



CTL5702

## Absolute Maximum Ratings $T_A = 25^{\circ}C$ , unless otherwise specified

Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only

Symbol	Parameters	Ratings	Units	Notes
Viso	Isolation voltage (AC, 1 minute, 40 ~ 60% R.H.)	5000	VRMS	
T <sub>OPR</sub>	Operating temperature	-40 ~ +110	0C	
Tstg	Storage temperature	-55 ~ +125	0C	
T <sub>SOL</sub>	Soldering temperature (For 10 seconds)	260	0C	
Ртот	Total power dissipation	300	mW	
Emitter				
I <sub>F</sub>	Forward current	25	mA	
IFP	Peak forward current (50% duty, 1ms P.W)	1	А	
VR	Reverse voltage	5	V	
Detecto	•			
PD	Power dissipation	250	mW	
VO(PEAK)	Peak Output Voltage	0 to 30	V	1
I <sub>OPH</sub>	Output High Peak Current	2.5	А	2
IOPL	Output Low Peak Current	2.5	А	2
Vcc	Supply voltage	0 to 30	V	

Notes

- 1. The  $V_{O(PEAK)}$  voltage CAN NOT BE high than  $V_{CC}$ .
- 2. The I<sub>0</sub> maximum pulse width = 10  $\mu$ s, maximum duty cycle = 0.2%.



### **Electrical Characteristics**

Over recommended operating conditions TA = -40 to 110 °C. Typical values are measured at  $V_{CC}=30V$ ,  $V_{EE}=GND$ ,  $T_A = 25^{\circ}C$  (unless otherwise stated)

#### **Emitter Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward voltage	IF = 10mA	-	1.45	1.8	V	
VR	Reverse Voltage	IR = 10µA	5.0	-	-	V	
A\/_/AT.	Temperature coefficient of	IF =10mA		10		mV/°C	
$\Delta V_F / \Delta T_A$	forward voltage	IF = IUMA	-	-1.8	-	mv/ C	

#### **Detector Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lcc∟	Logic Low Supply Current	$V_F = 0$ to 0.8V, $V_O = Open$	-	1.5	5		
Іссн	Logic High Supply Current	I <sub>F</sub> = 7mA to 10mA, V <sub>O</sub> = Open	-	1.5	5	mA	

#### **Transfer Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
Maria		I <sub>F</sub> = 10mA, I <sub>O</sub> = -2.5A	Vcc - 6	-	-	V	
Vон	High Level Output Voltage	I <sub>F</sub> = 10mA, I <sub>O</sub> = -100mA	V <sub>CC</sub> - 4	-	-	V	
M	Low Lovel Output Veltage	I <sub>F</sub> = 0mA, I <sub>O</sub> = 2.5A	-	-	V <sub>EE</sub> + 6	V	
Vol	Low Level Output Voltage	I <sub>F</sub> = 0mA, I <sub>O</sub> = 100mA	-	-	V <sub>EE</sub> + 4	v	
La ave	High Lovel Output Current	V <sub>O</sub> = V <sub>CC</sub> -3V	-	-	-1	A	1
Іорн	High Level Output Current	Vo= Vcc-6V	-	-	-2		1
		Vo= VEE+3V	1	-	-		1
I <sub>OPL</sub> Low Level Output Current	V <sub>O</sub> = V <sub>EE</sub> +6V	2	-	-	A	1	
IFLH	Input Threshold Current	Io= 0mA, Vo> 5V	-	1.4	5.0	mA	
Vfhl	Input Threshold Voltage	Io= 0mA, Vo< 5V	0.8	-	-	V	
V <sub>UVLO+</sub>	Under Voltage Lockout	I <sub>O</sub> = 10mA, V <sub>O</sub> > 5V	11	-	13.5	v	
Vuvlo-	Threshold	Io= 10mA, Vo< 5V	9.5	-	12.0	v	

#### Notes

1. The I<sub>0</sub> maximum pulse width = 10  $\mu$ s, maximum duty cycle = 0.2%.



### **Electrical Characteristics**

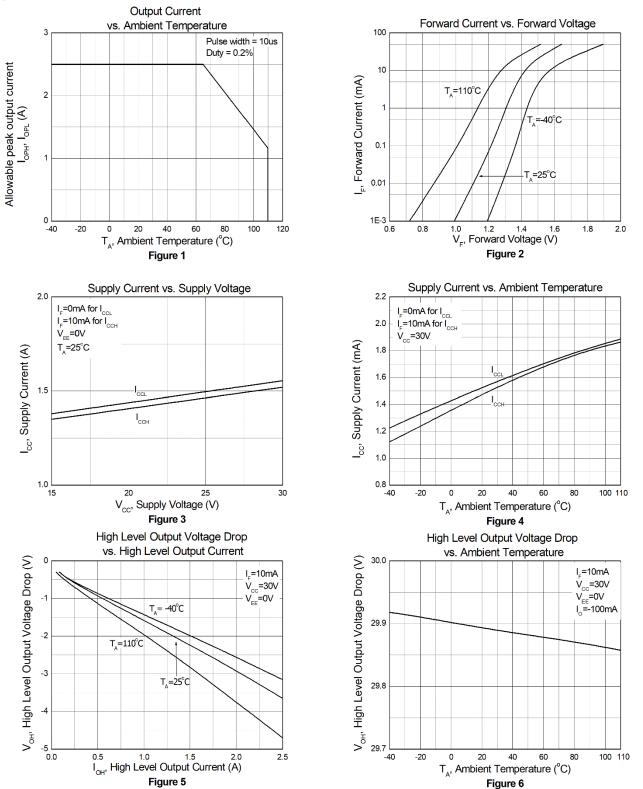
Over recommended operating conditions TA = -40 to 110 °C. Typical values are measured at  $V_{CC}=30V$ ,  $V_{EE}=$  GND,  $T_A = 25^{\circ}C$  (unless otherwise stated)

#### **Switching Characteristics**

Symbol	Parameters	Test C	onditions	Min	Тур	Max	Units	Notes
T <sub>PHL</sub>	High to Low Propagation Delay			50	180	300	ns	
TPLH	Low to High Propagation Delay	- I <sub>F</sub> = 7 to 16mA, C <sub>L</sub> = 10nF, - R <sub>L</sub> = 10Ω, f= 10kHz, Duty = - 50%, T <sub>A</sub> = 25 <sup>0</sup> C		50	140	300	ns	
P <sub>WD</sub>	Pulse Width Distortion				40	200	ns	
tрsк	Propagation Delay Skew					40	ns	
tr	Rise Time				20		ns	
t <sub>f</sub>	Fall Time				20		ns	
tuvlo(on)	UVLO Turn On Delay	I <sub>F</sub> = 10mA, V <sub>O</sub> > 5V			3.5		μs	
tuvlo(off)	UVLO Turn Off Delay	I <sub>F</sub> = 10mA, V <sub>C</sub>	< 5V		3		μs	
СМн	Common Mode Transient High	V <sub>CC</sub> = 30V, T <sub>A</sub> = 25 <sup>o</sup> C,	l⊧= 7 to 16mA	25			kV/µs	
CM∟	Common Mode Transient Low	V <sub>CM</sub> = 1.5kV	IF= 0mA	25			kV/µs	



#### Typical Characteristic Curves T<sub>A</sub> = 25°C, unless otherwise specified

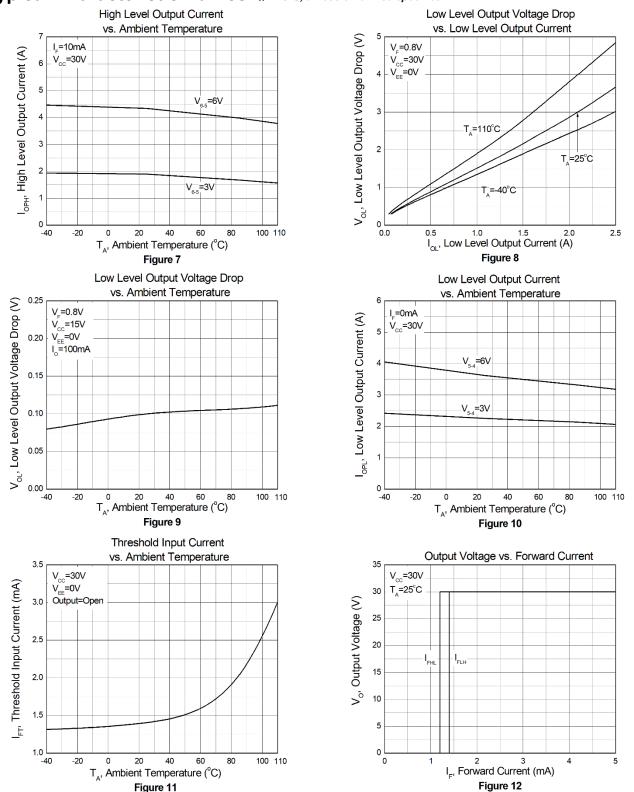




# CTL5702 5-Pin Long Mini-Flat DMC-Isolator®

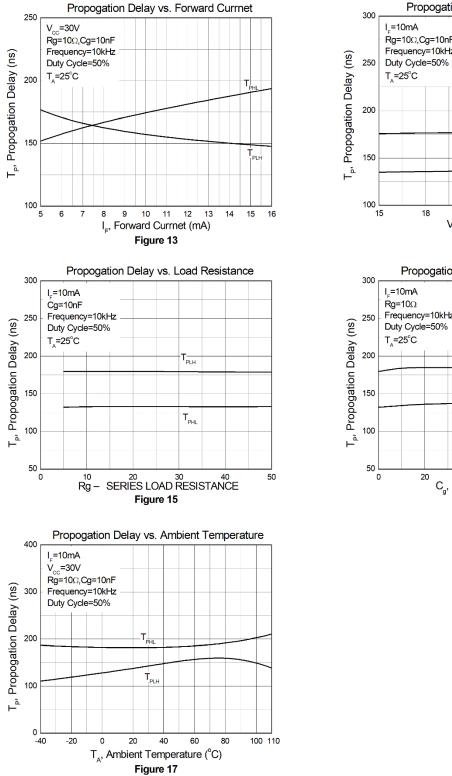
2.5A MOSFET/IGBT Gate Driver Optocoupler

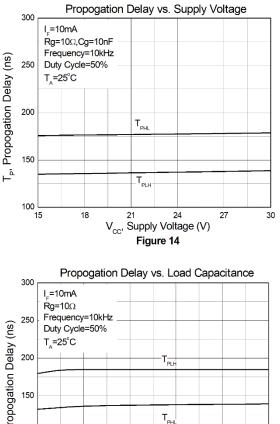
**Typical Characteristic Curves** *T<sub>A</sub>* = 25°*C*, unless otherwise specified





#### **Typical Characteristic Curves** $T_A = 25^{\circ}C$ , unless otherwise specified

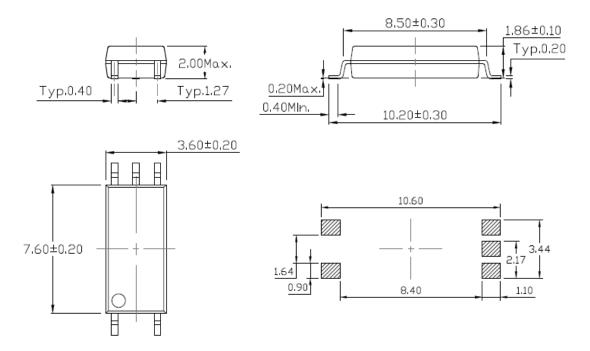




0 20 40 60 80 100 C<sub>g</sub>, Load Capacitance (nF) Figure 16



#### Package Dimension Dimensions in mm unless otherwise stated



## **Marking Information**



#### Note:

- CT : Denotes "CT Micro"
- L5702 : Part Number
- V : VDE Safety Mark Option (Blank or V)
- Y : One Digit Year Code
- WW : Two Digit Work Week
- K : Manufacturing Code



## CTL5702

## 5-Pin Long Mini-Flat DMC-Isolator®

2.5A MOSFET/IGBT Gate Driver Optocoupler

### **Ordering Information**

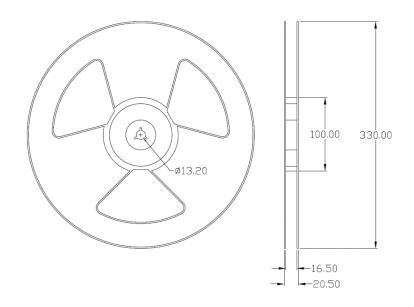
CTL5702(V)(Z)

- CT = Denotes "CT Micro"
- L5702 = Part Number
- V = VDE Safety Mark Option (Blank or V)
- Z = Tape and Reel Option (T1 or T2)

Option	Description	Quantity
T1	Surface Mount Lead Forming – With Option 1 Taping	3000Units/Reel
T2	Surface Mount Lead Forming – With Option 2 Taping	3000Units/Reel

## Reel Dimension All dimensions are in mm, unless otherwise stated

#### **Option T1/T2**

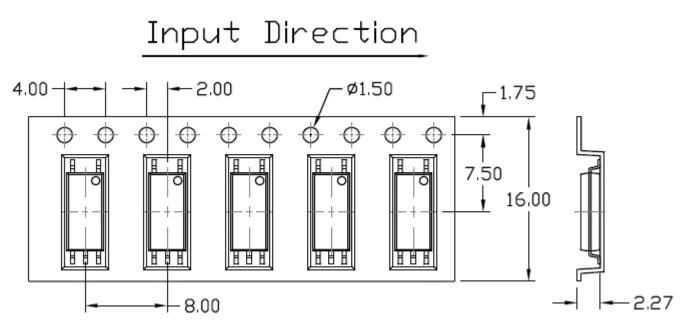




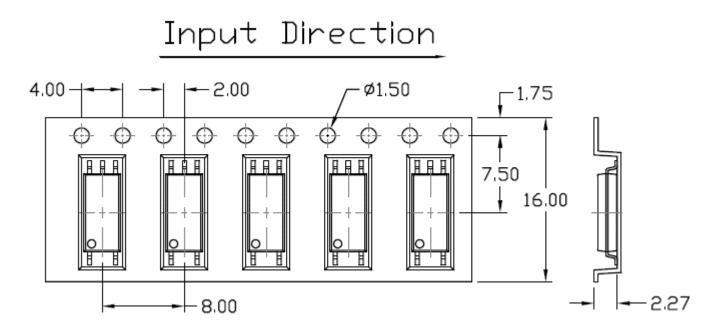
www.ct-micro.com

Carrier Tape Specifications Dimensions in mm unless otherwise stated

### Option T1



#### **Option T2**





5-Pin Long Mini-Flat DMC-Isolator®

2.5A MOSFET/IGBT Gate Driver Optocoupler

### Solderability spec (follow the JEDEC standard JESD22-B102)

Reflow Soldering: Immersed surface, other than the end of pin as cut-surface, must be covered by solder.

Solder-Bath: More than 95% of the electrode must be covered with solder.

### Wave soldering (follow the JEDEC standard JESD22-A111)

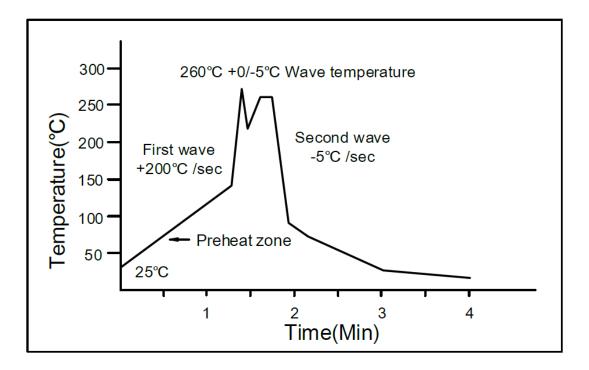
One time soldering is recommended within the condition of temperature.

Temperature: 260+0/-5°C.

Time: 10 sec.

Preheat temperature:25 to 140°C.

Preheat time: 30 to 80 sec.



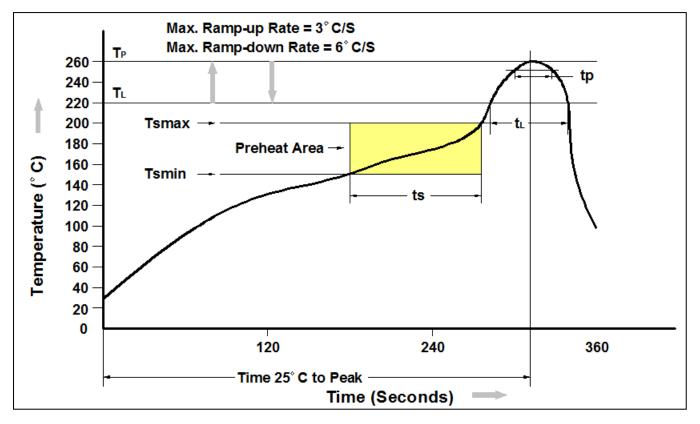
### Iron soldering (follow the standard MIL-STD 202G, Method 210F)

Allow single lead soldering in every single process. One time soldering is recommended. Temperature: 350+±10°C Time: 5 sec max.



2.5A MOSFET/IGBT Gate Driver Optocoupler

## **Reflow Profile (follow the JEDEC standard J-STD-020)**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t₀) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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